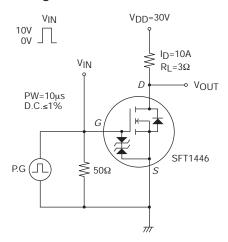
Electrical Characteristics at Ta=25°C

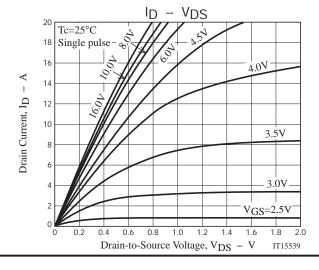
Parameter	Symbol	Conditions	Ratings			Unit
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	60			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =60V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =10A		7.0		S
	R _{DS} (on)1	I _D =10A, V _{GS} =10V		39	51	mΩ
Static Drain-to-Source On-State Resistance	R _{DS} (on)2	I _D =5A, V _{GS} =4.5V		54	76	$m\Omega$
	R _{DS} (on)3	I _D =5A, V _{GS} =4V		62	87	mΩ
Input Capacitance	Ciss			750		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		59		pF
Reverse Transfer Capacitance	Crss			47		pF
Turn-ON Delay Time	t _d (on)			8.5		ns
Rise Time	t _r	Can appointed Toot Circuit		31		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		60		ns
Fall Time	tf			48		ns
Total Gate Charge	Qg			16		nC
Gate-to-Source Charge	Qgs	V _{DS} =30V, V _{GS} =10V, I _D =14A		3.3		nC
Gate-to-Drain "Miller" Charge	Qgd			3.6		nC
Diode Forward Voltage	V _{SD}	I _S =20A, V _{GS} =0V		1.01	1.2	V

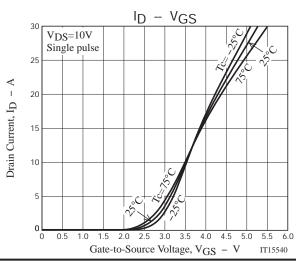
Switching Time Test Circuit

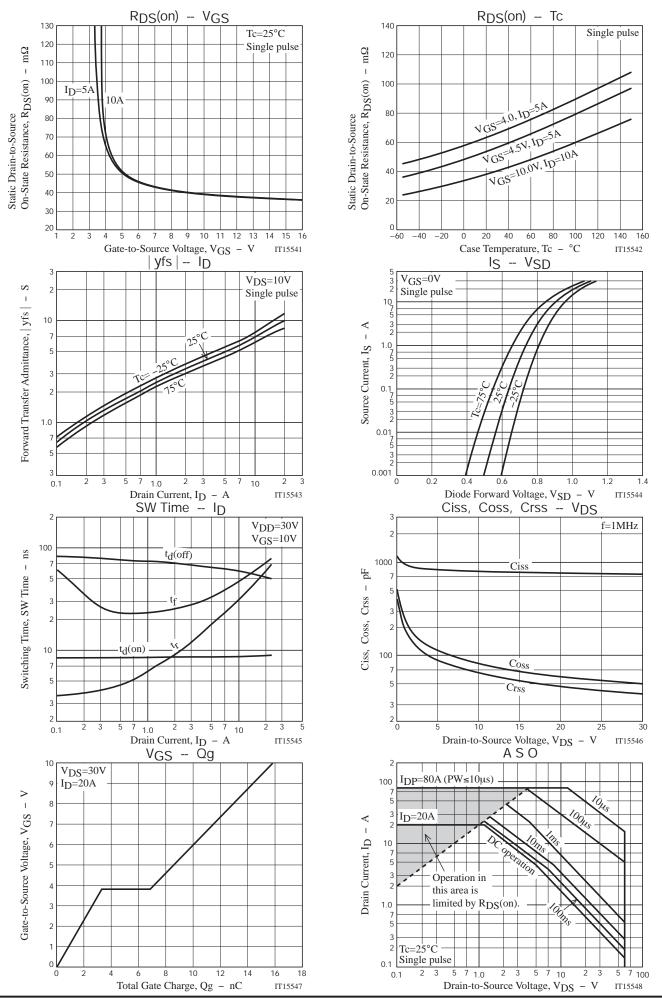


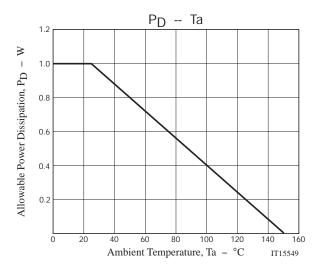
Ordering Information

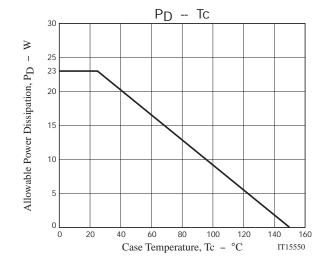
Device	Package	Shipping	memo
SFT1446-H	TP	500pcs./bag	Db Free and Helegen Free
SFT1446-TL-H	TP-FA	700pcs./reel	Pb Free and Halogen Free









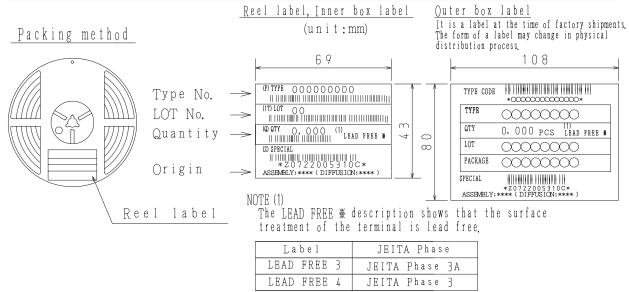


Taping Specification

SFT1446-TL-H

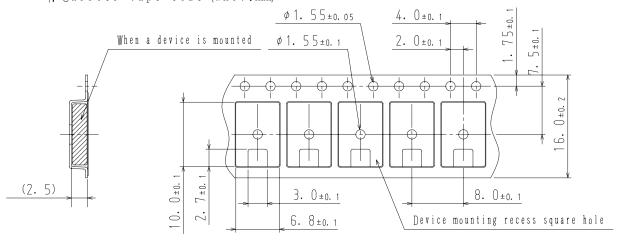
Packing Format

Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing	Packing format		
	Туре	Reel	Inner box	Outer box	Inner $BOX(C-1)$	Outer BOX (A-7)		
TP-FA	TP	700	2, 100	12, 600	3 reels contained	6 inner boxes contained		
					Dimensions:mm (external)	Dimensions:mm (external)		
					183×72×185	440×195×210		

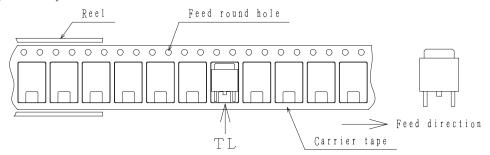


Taping configuration

1. Carrier tape size (unit:mm)



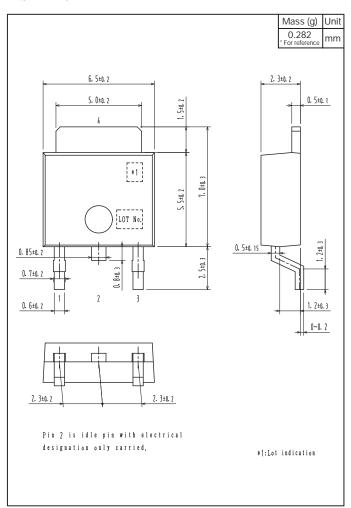
2. Device placement direction

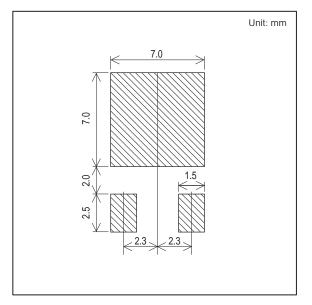


Those with one electrode terminal on the feed hole side·····TL

Outline Drawing SFT1446-TL-H

Land Pattern Example



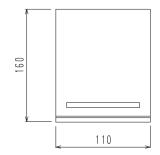


Bag Packing Specification SFT1446-H

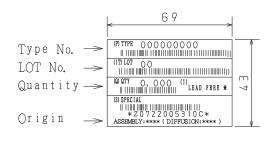
1. Packing Format

Package Name	Maximum Number of devices contained (pcs)				
I wonago Mamo	Bag	Inner box	Outer box		
ТР		B-1	A-1	A-2	
1 1 1	500	10,000	50,000	30,000	
	•	Packing fo	ormat (Dimensions:mm (external))		
		Inner box	Inner box Outer box		
		B-1	A-1	A-2	
L		445×225×55	470×250×300	470×250×190	

2. Bag dimensions (unit:mm)





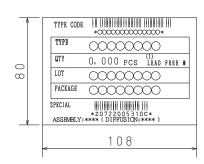


4. Outer box label (unit:mm)

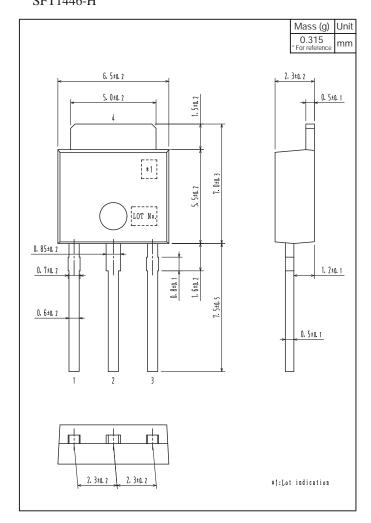
It is a label at the time of factory shipments, The form of a label may change in physical distribution process,



Label		JEITA Phase		
LEAD FREE	3	JEITA Phase 3A		
LEAD FREE	4	JEITA Phase 3		



Outline Drawing SFT1446-H



Note on usage: Since the SFT1446 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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